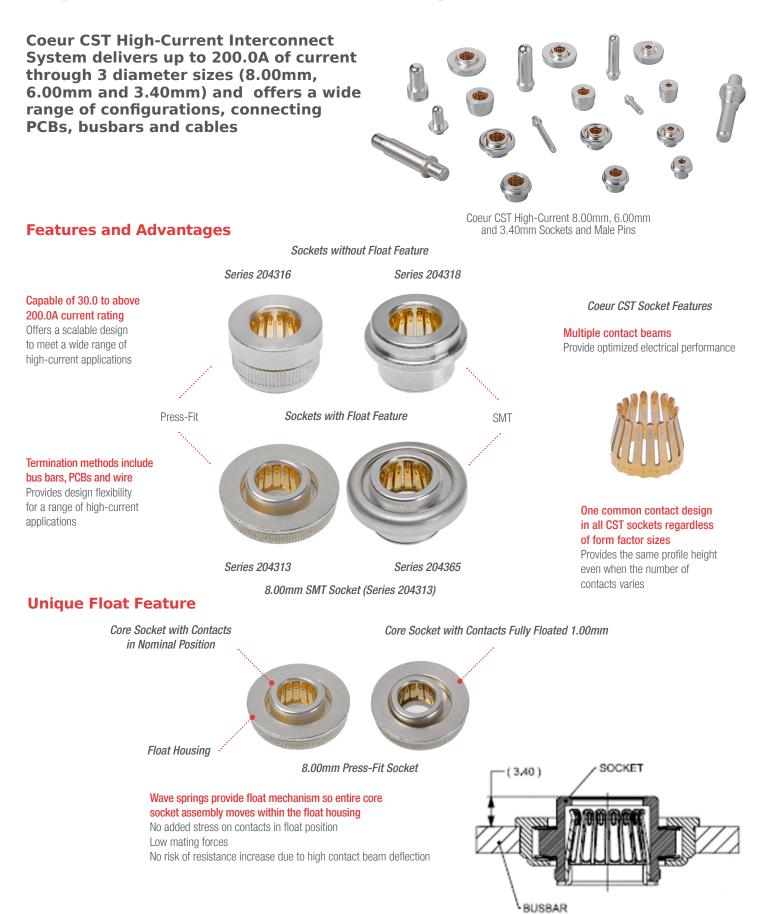
Coeur CST High-Current Interconnect System **molex**



Coeur CST High-Current Interconnect System

molex

Previous housing features available

· Vertical, PC, bus bar-mounting header

• Touch-safe feature

· Positive latching



Fully shrouded female and male contacts Touch safe. 600V rating in configuration show above 8.0mm Coeur CST Interconnector System,



2-Circuit, Wire-to-Board (Female Housing: Series

204601, 204603; Male Header: Series 204600;

Male Pin: Series 203263)

2-circuit, 8.00mm version shown is currently available. 2-circuit, 6.00mm available upon request Plan is for a broad W-to-W/W-to-B product portfolio in all 3 sizes

Male pin does not protrude above the socket housing when mated by a top entry Saves space above the PCB or bus bar

Coeur CST Connector Embedded in a Bus Bar



Coeur CST Connector Mounted to a PCB

Pick-and-place cap available Enables automated SMT socket placement to PCB

Applications

Board-to-Board Mated Height Changes by Varying Male Pin Length (Series 203263)

Data/Computing

- Routers
- Networking
- .
- Storage

Telecommunications/Networking

Servers

Storage

Industrial

Power Supply

Data Centers

Servers Data Storage PDU UPS/Battery Storage Switches Circuit Breakers Instrumentation



Data Center Servers

Coeur CST High-Current Interconnect System **molex**

Specifications

REFERENCE INFORMATION

Packaging: Tray, Tape, Reel and Bag per part number see PK specs UL File No.: E29179 CSA File No.: 70184994 Use With: Busbars and Cable Assemblies Designed In: Millimeters RoHS: Yes Halogen Free: Yes

8.00MM

ELECTRICAL

Voltage: 600V Current (max.): 200.0A Contact Resistance: 0.20 milliohms

MECHANICAL

Contact Mating Force (max.): 40N Contact Unmating Force (minx): 10N Durability (min.): 200 Mating Cycles Float Displacement Force (max.): 15N

PHYSICAL

Contact: High-Performance Copper (Cu) Alloy Metal Housings/Caps: Copper (Cu) Alloy Plating: Contact Beams — Gold (Au) over Nickel (Ni) Wave Springs (Float Versions) — Gold (Au) over Nickel (Ni) Male Pin — Silver (Ag) over Nickel (Ni) Metal Housings / Caps — Silver (Ag) over Nickel (Ni) PCB Thickness (min.): 1.60mm Bus Bar Thickness (min.): 1.50mm Operating Temperature: -40 to +105°C

6.00MM

ELECTRICAL Voltage: 600V

Current (max.): 140.0A Contact Resistance: 0.20 milliohms

MECHANICAL

Contact Mating Force (max.): 30N Contact Unmating Force (minx): 7N Durability (min.): 200 Mating Cycles Float Displacement Force (max.): 10N

3.40MM

ELECTRICAL Voltage: 600V Current (max.): 75.0A Contact Resistance: 0.25 milliohms

MECHANICAL

Contact Mating Force (max.): 20N Contact Unmating Force (minx): 6N Durability (min.): 200 Mating Cycles Float Displacement Force (max.): 10N